REACH Customer Information

Declaration to the EU regulation (EG) No. 1907/2006 “REACH"

According to the REACH regulations Janz Tec AG, as a manufacturer of “articels”, is a so-called “downstream user”. In this case we are not subject to the registration requirement.

A registration requirement for downstream users exists only at direct imports of substances and preparations outside the EU. This is not the case for our company. Under normal and appropriate application circumstances, the substances used in our products are not going to be released.

We are aware that the substances included in the REACH Authorization list Annex XIV shall not be placed on the market after their sunset date. We declare that to our knowledge none of the substances subject to Annex XIV restrictions is present in Janz Tec AG products.

In Annex XVII of REACH, dangerous substances are listed in total to explain the restrictions on purpose of potential use and the conditions of producing, using, and consuming when placing in the EU market. We declare that to our knowledge none of the substances subject to Annex XVII restrictions is present in Janz Tec AG products. Except the substance listed in Annex 1 of this document, we declare that our method of substance-use is not subject to the usage restrictions set out in "REACH" Annex XVII.

We also are aware that Article 33 of REACH requires suppliers to inform the recipients and consumers if a purchased article contains more than 0.1%(by weight per article) of any substance(s) on the candidate list of substances of Very High Concern (SVHC). Except for the SVHC listed in Annex 1, the other SVHC are not present above 0.1% by weight in article of product listed above.

This declaration refers to the candidate list as of 2019-07-16 with 201 SVHC substances.

If there are any relevant changes by REACH concerning our products, the ability in delivering or in quality we will communicate this to you in line with our business relations and if it is necessary, we try to find solutions in individual cases.

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-Management-

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Annex 1 – REACH SVHCs – Present above 0.1 wt% in article of Janz Tec AG products

Date of ECHA inclusion	Substance	CAS Number	EC Number	Typical Use
2012/06/18	1,2-dimethoxyethane; ethylene glycol dimethyl ether (EGDME)	110-71-4	203-794-9	Battery (Coin Cells)
2012/12/19	Lead monoxide (lead oxide)	1317-36-8	215-267-0	The Product are RoHS Compliant with Exemption 7(c)-I
2012/12/19	Lead titanium trioxide	12060-00-3	235-038-9	The Product are RoHS Compliant with Exemption 7(c)-I; 7(c)-II
2017/1/12	4,4'-isopropylidenediphenol (Bisphenol A; BPA)	80-05-7	201-245-8	SDRAM; RAM Module; HDD; SSD
2018/6/27	Lead	7439-92-1	231-100-4	The Product are RoHS Compliant with Exemption 6(a); 6(b); 6(c); 7(a); 7(c)-I; 15
2012/12/10	Lead titanium zirconium oxide	12626-81-2	235-727-4	HDD; SSD

RoHS Exemption Description

6(a)	Lead as an alloying element in steel for machining purposes and in galvanised steel containing up to 0,35 % lead by weight.
6(b)	Lead as an alloying element in aluminum containing up to 0,4 % lead by weight
6(c)	Copper alloy containing up to 4 % lead by weight
7(a)	Lead in high melting temperature type solders (i.e. lead- based alloys containing 85 % by weight or more lead)
7(c)-I	Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezo electronic devices, or in a glass or ceramic matrix compound
7(c)-II	Lead in dielectric ceramic in capacitors for a rated voltage of 125 V AC or 250 V DC or higher
15	Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit flip chip packages